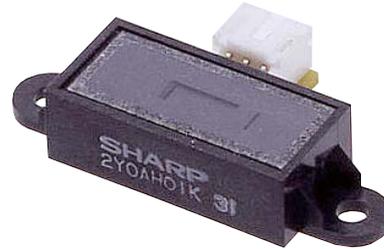


GP2Y0AH01K0F

High-precision Displacement Sensor Unit

Measuring distance: 4.5 to 6.0 mm
Analog output type



■Description

GP2Y0AH01K0F is a distance measuring sensor unit, composed of an integrated combination of PSD (position sensitive detector), IRED (infrared emitting diode) and signal processing circuit.

The variety of the reflectivity of the object, the environmental temperature and the operating duration are not influenced easily to the distance detection because of adopting the triangulation method.

This device outputs the voltage corresponding to the detection distance. So this sensor can also be used as a proximity sensor.

■Features

1. High-accuracy type
Distance measuring range : 4.5 to 6.0 mm
2. Analog output type
3. Package size : 27×21.2×8.5 mm
4. Consumption current : Typ. 20 mA
5. Supply voltage : 4.5 to 5.5 V
6. Resolution : 50μm

■Agency approvals/Compliance

1. Compliant with RoHS directive(2002/95/EC)
2. Content status of six substances specified in “Management Methods for Control of Pollution Caused by Electronic Information Products Regulation” (popular name : *China RoHS*) (Chinese : 电子信息产品污染控制管理办法) ; refer to page 7

■Applications

1. Copier
2. Multi-function equipment
3. Laser beam printer

Notice The content of data sheet is subject to change without prior notice.

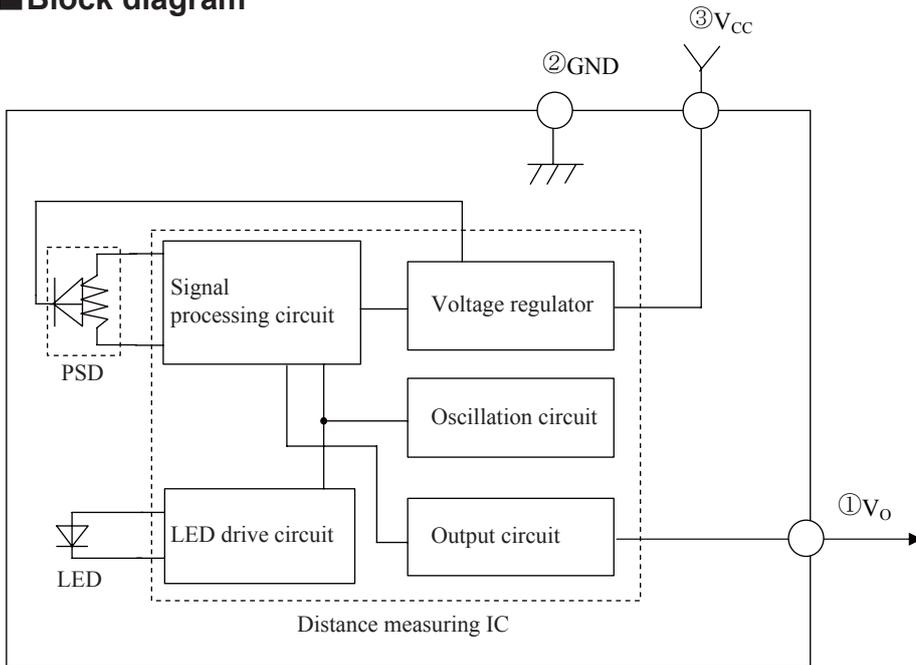
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Sheet No.: E4-A00401EN

Date Mar.01.2007

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■ Block diagram



■ Outline Dimensions

(Unit : mm)

Stamp (Example)

SHARP
2Y0AH01 F 2 7
Model name

Production month : Jan. to Sep. ; 1 to 9
Oct. ; X, Nov. ; Y, Dec. ; Z
Production year : Last digit of prod. year

Connector : J.S.T. TRADING COMPANY, LTD. S3B-PH

Note 1 : * marked dimensions are the width between the body edge and the center of light emitting slit, and the width between the slit centers of light emitting and light receiving slits.
 Note 2 : Unspecified tolerance shall be ± 0.3 mm.
 Note 3 : Dimensions in parenthesis are shown for reference
 Note 4 : Do not touch the lead pins of connector at mounting.
 Note 5 : Dimension of (A) may be larger than dimension of (B) .

Terminal	Symbol
① Output terminal voltage	V _O
② Ground	GND
③ Supply voltage	V _{CC}

Product mass : approx. 3.0g

■ Absolute Maximum Ratings (Ta=25°C, Vcc=5V)

Parameter	Symbol	Rating	Unit
Supply voltage	V _{CC}	-0.3 to +7	V
Output terminal voltage	V _O	-0.3 to V _{CC} +0.3	V
Operating temperature	T _{opr}	-10 to +60	°C
Storage temperature	T _{stg}	-40 to +70	°C

■ Electro-optical Characteristics (Ta=25°C, Vcc=5V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Average supply current	I _{CC}	(Note 1)	—	20	40	mA
Distance measuring	ΔL	(Note 1)	4.5	—	6.0	mm
Output voltage	V _O	L=6.0mm (Note 1)	0.35	0.5	0.65	V
Output voltage differential	ΔV _O	Output voltage difference between L=4.5mm and L=6.0mm (Note 1)	1.45	1.70	2.0	V

* L : Distance to reflective object

Note 1 : Using reflective object : White paper (Made by Kodak Co., Ltd. gray cards R-27•white face, reflectance; 90%)

■ Recommended operating conditions

Parameter	Symbol	Rating	Unit
Supply voltage	V _{CC}	4.5 to 5.5	V

Fig. 1 Timing chart

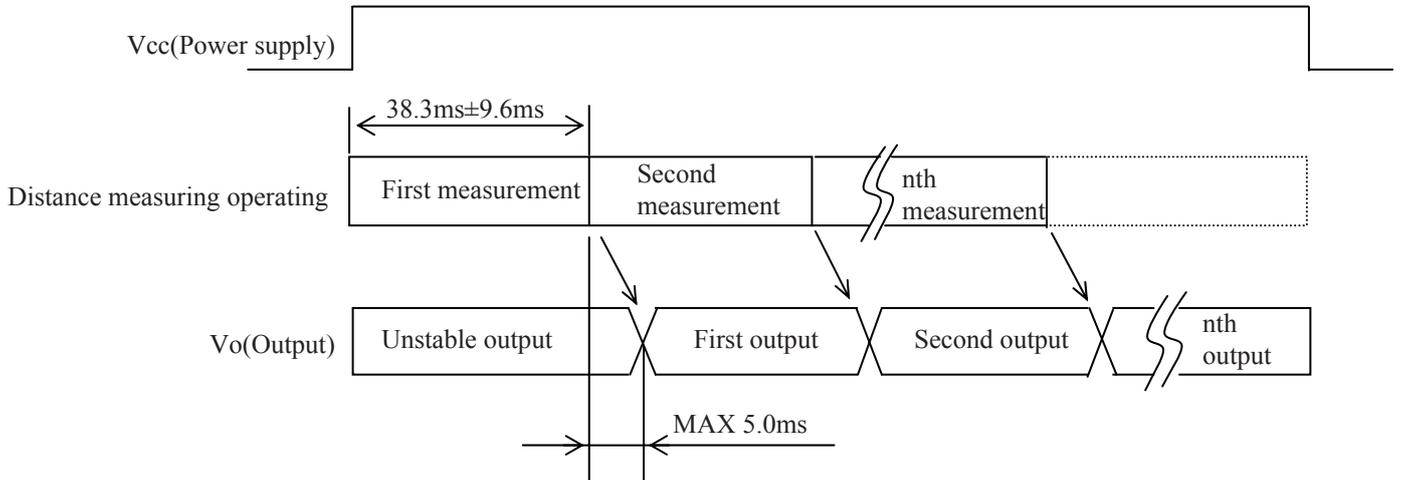
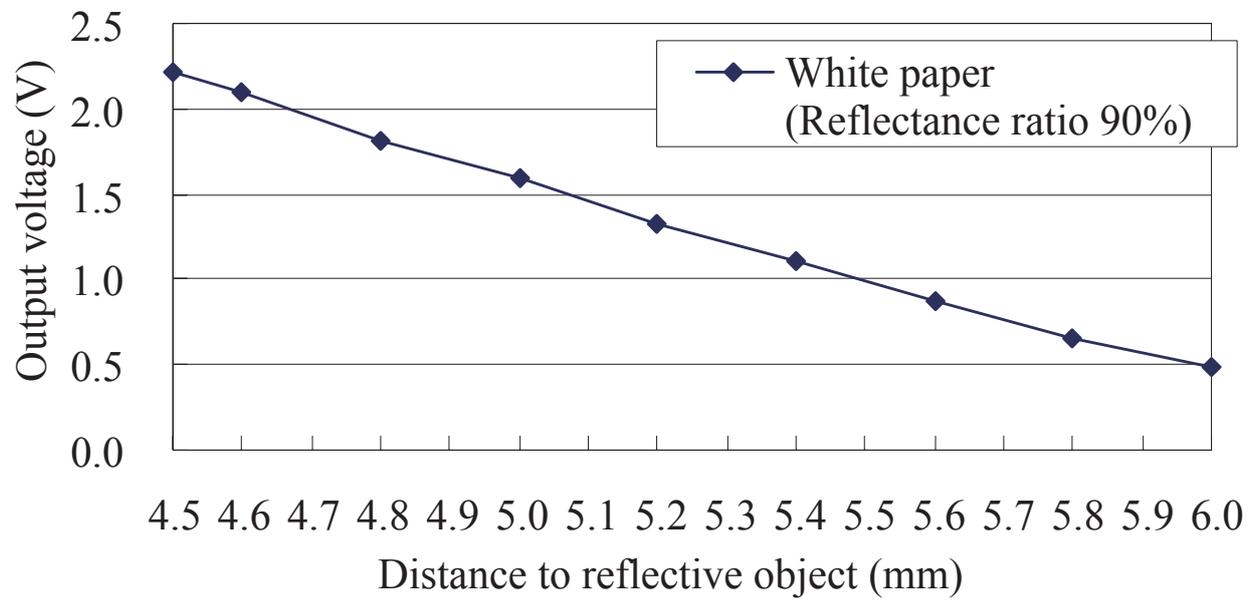


Fig. 2 Example of distance measuring characteristics (output)

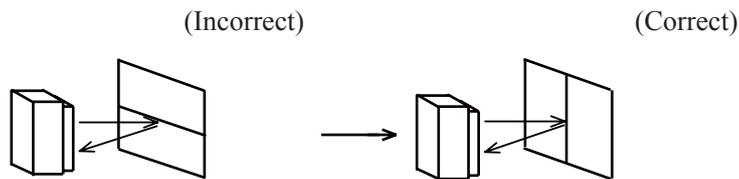
■Notes

●Advice for the optics

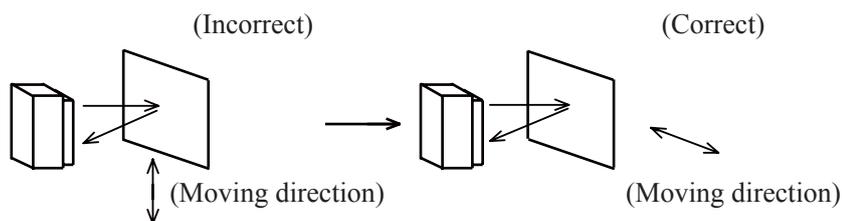
- The lens of this device needs to be kept clean. There are cases that dust, water or oil and so on deteriorate the characteristics of this device. Please consider in actual application.
- Please don't do washing. Washing may deteriorate the characteristics of optical system and so on. Please confirm resistance to chemicals under the actual usage since this product has not been designed against washing.

●Advice for the characteristics

- In case that an optical filter is set in front of the emitter and detector portion, the optical filter which has the most efficient transmittance at the emitting wavelength range of LED for this product ($\lambda = 870 \pm 70\text{nm}$), shall be recommended to use. Both faces of the filter should be mirror polishing. Also, as there are cases that the characteristics may not be satisfied according to the distance between the protection cover and this product or the thickness of the protection cover, please use this product after confirming the operation sufficiently in actual application.
- In case that there is an object near to emitter side of the sensor between sensor and a detecting object, please use this device after confirming sufficiently that the characteristics of this sensor do not change by the object.
- When the detector is exposed to the direct light from the sun, tungsten lamp and so on, there are cases that it can not measure the distance exactly. Please consider the design that the detector is not exposed to the direct light from such light source.
- Distance to a mirror reflector can not be sometimes measured exactly. In case of changing the mounting angle of this product, it may measure the distance exactly.
- In case that reflective object has boundary line which material or color etc. are excessively different, in order to decrease deviation of measuring distance, it shall be recommended to set the sensor that the direction of boundary line and the line between emitter center and detector center are in parallel.



- In order to decrease deviation of measuring distance by moving direction of the reflective object, it shall be recommended to set the sensor that the moving direction of the object and the line between emitter center and detector center are vertical.



●Advice for the power supply

- In order to stabilize power supply line, we recommend to insert a by-pass capacitor of $10\mu\text{F}$ or more between Vcc and GND near this product.

●Notes on handling

- There are some possibilities that the internal components in the sensor may be exposed to the excessive mechanical stress. Please be careful not to cause any excessive pressure on the sensor package and also on the PCB while assembling this product.

● **Cleaning Instructions**

Solvent cleaning :

Solvent temperature 45°C or less, Immersion for 3 min or less

Ultrasonic cleaning :

The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PCB size or device mounting condition etc.

Please test it in actual using condition and confirm that doesn't occur any defect before starting the ultrasonic cleaning. The cleaning shall be carried out with solvent below.

Recommended Solvent materials :

Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

● **Presence of ODC etc.**

This product shall not contain the following materials.

And they are not used in the production process for this product.

Regulation substances : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBB and PBDE are not used in this product at all.

- The RoHS directive (2002/95/EC)

This product complies with the RoHS directive (2002/95/EC).

Object substances: lead (except for lead in glass of electronic components), cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)

- Content of six substances specified in “ Management Methods for Control of Pollution Caused by Electronic Information Products Regulation ” (Chinese : 电子信息产品污染控制管理办法)

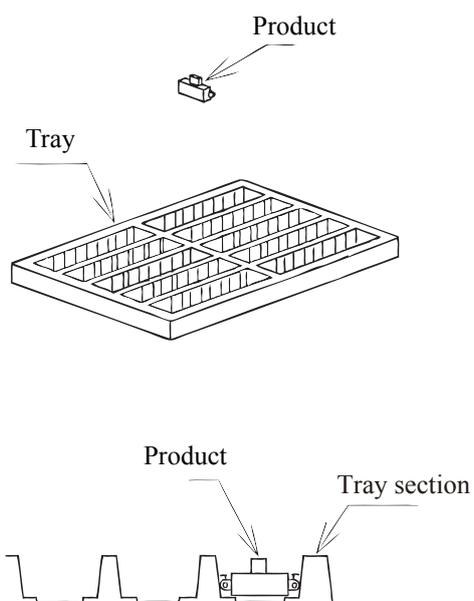
Category	Toxic and hazardous substances					
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent chromium (Cr ⁶⁺)	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)
Infrared data communication device	*	✓	✓	✓	✓	✓

✓ : indicates that the content of the toxic and hazardous substance in all the homogeneous materials of the part is below the concentration limit requirement as described in SJ/T 11363-2006 standard.

* : indicates that the content of the toxic and hazardous substance in at least one homogeneous material of the part exceeds the concentration limit requirement as described in SJ/T 11363-2006 standard.

Lead in glass of electronic components (designated by “*” in the above table) are exempt from the RoHS directive (2002/95/EC), because there is no effective way to eliminate or substitute them by present scientific technology.

■ Package specification



MAX. 100 pieces per tray

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- Personal computers
- Office automation equipment
- Telecommunication equipment [terminal]
- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics

(ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

with equipment that requires higher reliability such as:

- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

(iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:

- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).

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